# EVERLIGHT ELECTRONICS CO.,LTD.

### **Technical Data Sheet**

# 0805 Package Chip LED (1.0mm Height)

### 17-21/GPC-AK0M1B/3T

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb free
- The product itself will remain within RoHS compliant version

### **Descriptions**

- The 17-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

### **Applications**

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

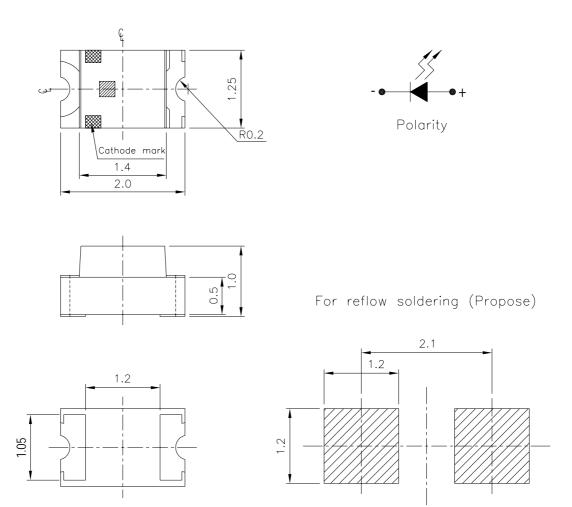
### **Device Selection Guide**

| Part No.            | Chip     | Emitted Color | Resin Color |  |
|---------------------|----------|---------------|-------------|--|
| rart No.            | Material | Emitted Color |             |  |
| 17-21/GPC-AK0M1B/3T | AlGaInP  | Pale Green    | Water Clear |  |





# **Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. Device No:SZDSE-171-G45

http://www.everlight.com Prepared date:14-Jun-2007 Rev. 1

Page: 2 of 10



### **Absolute Maximum Ratings (Ta=25°C)**

| Parameter                              | Symbol      | Rating   | Unit                   |
|--|-------------|--|------------------------|
| Reverse Voltage                        | $V_R$       | 5  | V                      |
| Forward Current                        | $ m I_F$    | 25   | mA                     |
| Peak Forward Current (Duty 1/10 @1KHz) | $ m I_{FP}$ | 60   | mA                     |
| Power Dissipation                      | Pd          | 60   | mW                     |
| Electrostatic Discharge(HBM)           | ESD         | 2000   | V                      |
| Operating Temperature                  | Topr        | -40 ~ +85  | $^{\circ}\!\mathbb{C}$ |
| Storage Temperature                    | Tstg        | -40 ~ +90  | $^{\circ}\!\mathbb{C}$ |
| Soldering Temperature                  | Tsol        | Reflow Soldering : 260 °C  Hand Soldering : 350 °C |                        |

# **Electro-Optical Characteristics (Ta=25°C)**

| Parameter                    | Symbol           | Min.  | Тур. | Max.  | Unit    | Condition            |
|------------------------------|------------------|-------|------|-------|---------|----------------------|
| Luminous Intensity           | $I_{\rm v}$      | 7.20  |      | 22.5  | mcd     |                      |
| Viewing Angle                | 2 0 1/2          |       | 140  |       | deg     |                      |
| Peak Wavelength              | λр               |       | 561  |       | nm      |                      |
| Dominant Wavelength          | λd               | 557.5 |      | 567.5 | nm      | $I_F = 20 \text{mA}$ |
| Spectrum Radiation Bandwidth | Δλ               |       | 20   |       | nm      |                      |
| Forward Voltage              | $V_{\mathrm{F}}$ | 1.75  |      | 2.35  | V       |                      |
| Reverse Current              | $I_R$            |       |      | 10    | $\mu$ A | $V_R=5V$             |

### **Notes:**

- 1. Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

Everlight Electronics Co., Ltd. Device No:SZDSE-171-G45

http://www.everlight.com

Prepared date:14-Jun-2007

Rev. 1

Page: 3 of 10



### Bin Rang Of Dom. Wavelength

| Group | Bin | Min   | Max   | Unit | Condition    |
|-------|-----|-------|-------|------|--------------|
|       | C10 | 557.5 | 559.5 |      |              |
|       | C11 | 559.5 | 561.5 |      |              |
| A     | C12 | 561.5 | 563.5 | nm   | $I_F = 20mA$ |
|       | C13 | 563.5 | 565.5 |      |              |
|       | C14 | 565.5 | 567.5 |      |              |

### **Bin Rang Of Luminous Intensity**

| Bin | Min  | Max  | Unit | Condition            |
|-----|------|------|------|----------------------|
| K0  | 7.20 | 11.5 | mcd  | I <sub>F</sub> =20mA |
| L1  | 11.5 | 14.5 |      |                      |
| L2  | 14.5 | 18.0 |      |                      |
| M1  | 18.0 | 22.5 |      |                      |

### **Bin Rang Of Luminous Voltage**

| Group | Bin | Min  | Max  | Unit | Condition            |
|-------|-----|------|------|------|----------------------|
| В     | 0   | 1.75 | 1.95 | V    | I <sub>F</sub> =20mA |
|       | 1   | 1.95 | 2.15 |      |                      |
|       | 2   | 2.15 | 2.35 |      |                      |

### **Notes:**

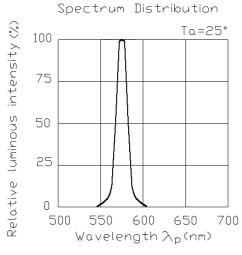
- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3. Tolerance of Forward Voltage ±0.1V

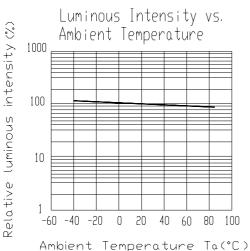


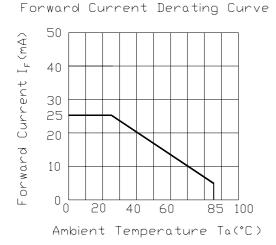
# EVERLIGHT ELECTRONICS CO.,LTD.

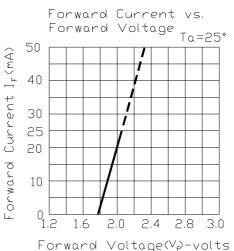
### 17-21/GPC-AK0M1B/3T

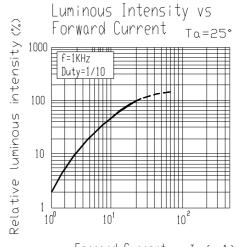
### **Typical Electro-Optical Characteristics Curves**

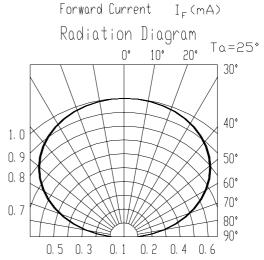












### Label explanation

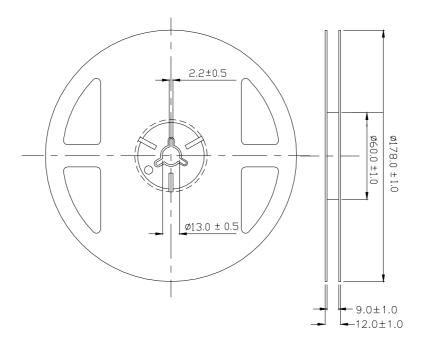
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

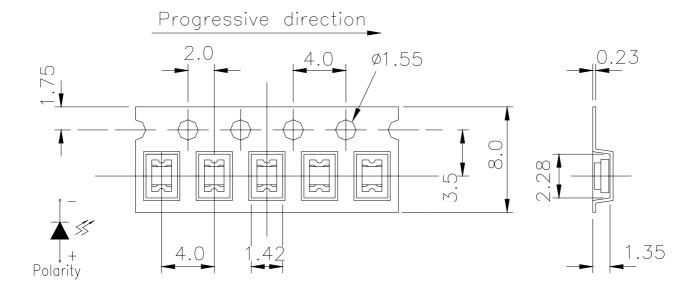
Everlight Electronics Co., Ltd. Device No:SZDSE-171-G45

http://www.everlight.com Prepared date:14-Jun-2007 Rev. 1

Page: 6 of 10

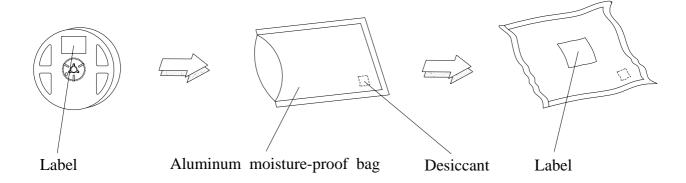


### Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

# **Moisture Resistant Packaging**





### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

| No. | Items                               | Test Condition  | Test<br>Hours/Cycles | Sample<br>Size | Ac/Re |
|-----|-------------------------------------|---|----------------------|----------------|-------|
| 1   | Reflow Soldering                    | Temp. : 260°C±5°C<br>Min. 5sec.   | 6 Min.               | 22 PCS.        | 0/1   |
| 2   | Temperature Cycle                   | $H: +100^{\circ}\mathbb{C}$ 15min<br>$\int 5 \text{ min}$<br>$L: -40^{\circ}\mathbb{C}$ 15min | 300 Cycles           | 22 PCS.        | 0/1   |
| 3   | Thermal Shock                       | $H: +100^{\circ}\mathbb{C}$ 5min<br>$\int 10 \sec$<br>$L: -10^{\circ}\mathbb{C}$ 5min         | 300 Cycles           | 22 PCS.        | 0/1   |
| 4   | High Temperature<br>Storage         | Temp. : 100°C   | 1000 Hrs.            | 22 PCS.        | 0/1   |
| 5   | Low Temperature<br>Storage          | Temp. : -40°€   | 1000 Hrs.            | 22 PCS.        | 0/1   |
| 6   | DC Operating Life                   | $I_F = 20 \text{ mA}$   | 1000 Hrs.            | 22 PCS.        | 0/1   |
| 7   | High Temperature /<br>High Humidity | 85°C / 85%RH  | 1000 Hrs.            | 22 PCS.        | 0/1   |

Everlight Electronics Co., Ltd. Device No:SZDSE-171-G45

http://www.everlight.com Prepared date:14-Jun-2007 Rev. 1

Page: 8 of 10

#### **Precautions For Use**

1. Over-current-proof

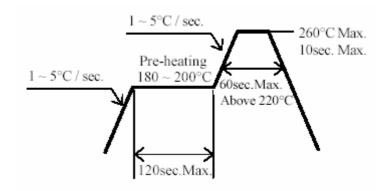
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90% RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less.

  If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
  - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. Device No:SZDSE-171-G45

http://www.everlight.com

Rev. 1

Page: 9 of 10

Prepared date:14-Jun-2007

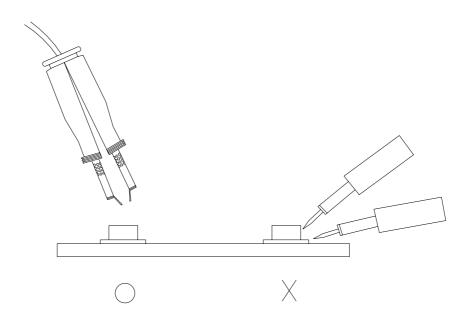


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. Device No:SZDSE-171-G45

http://www.everlight.com

Rev. 1

Page: 10 of 10

Prepared date:14-Jun-2007

# 单击下面可查看定价,库存,交付和生命周期等信息

>>Everlight(亿光)